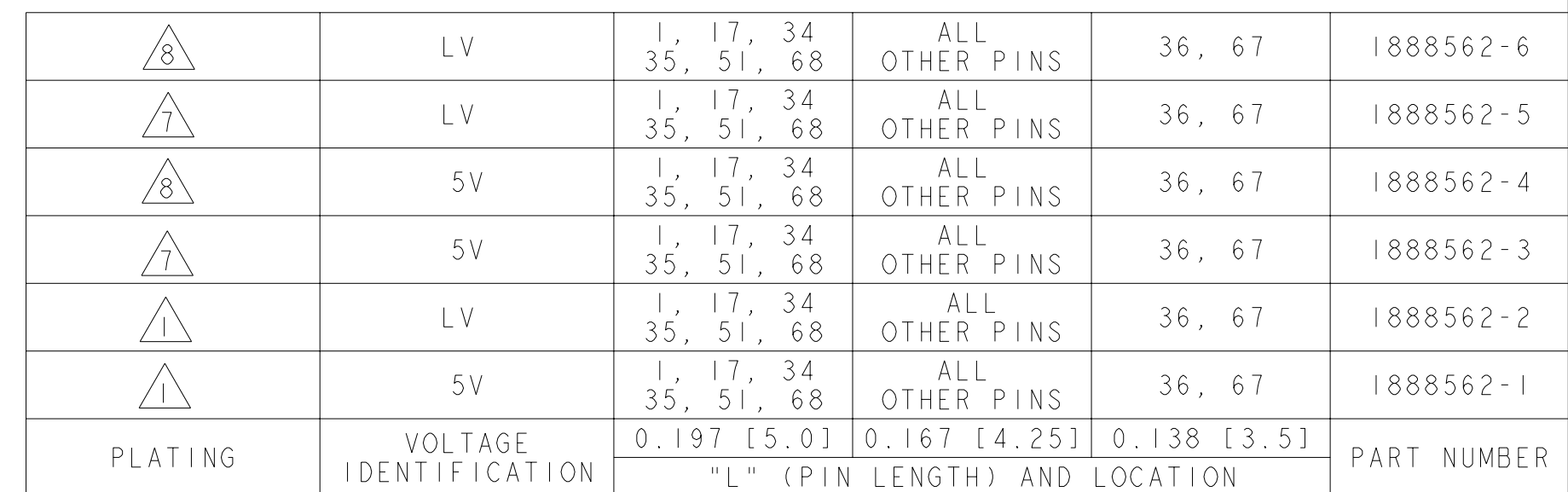
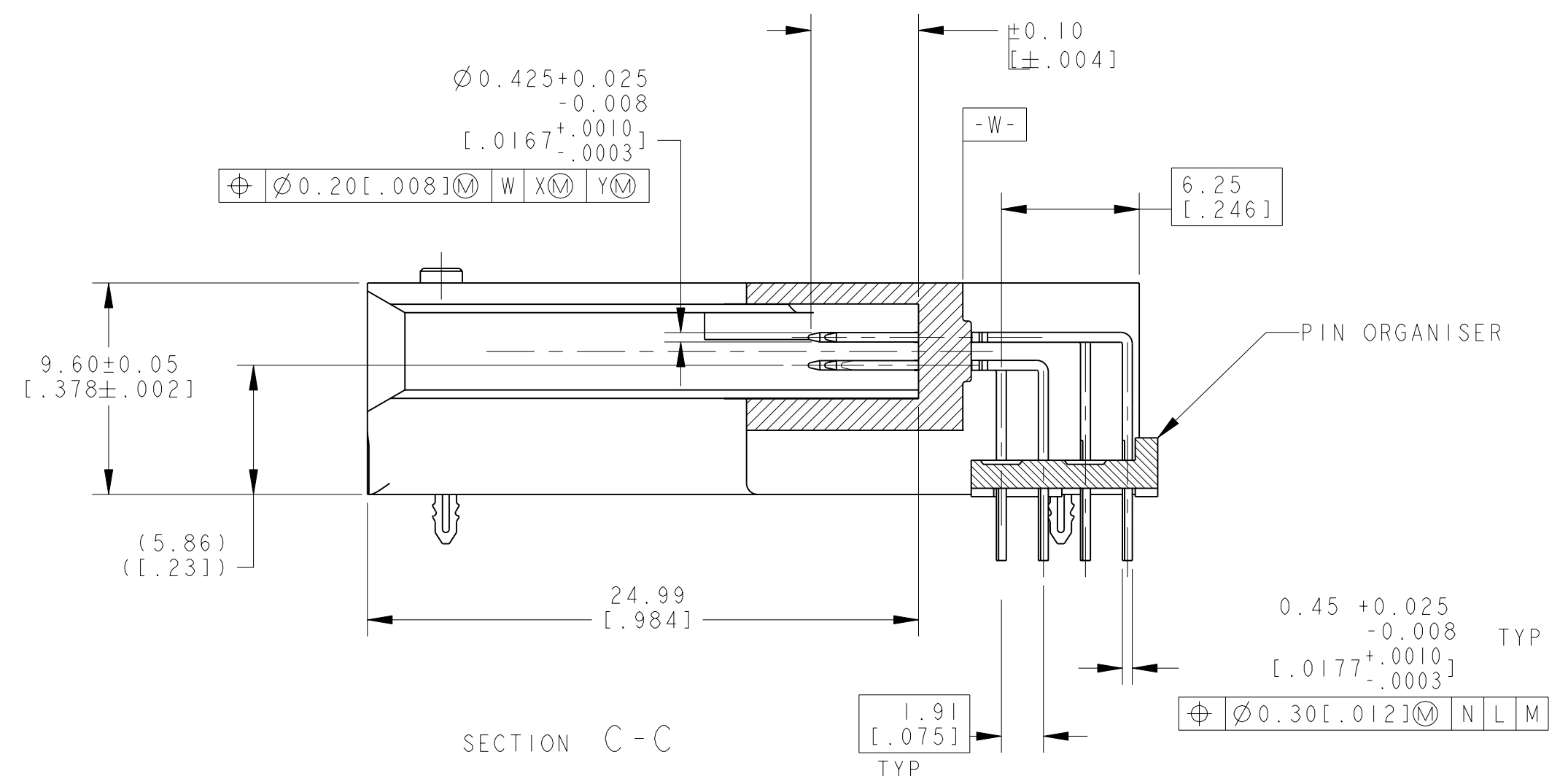
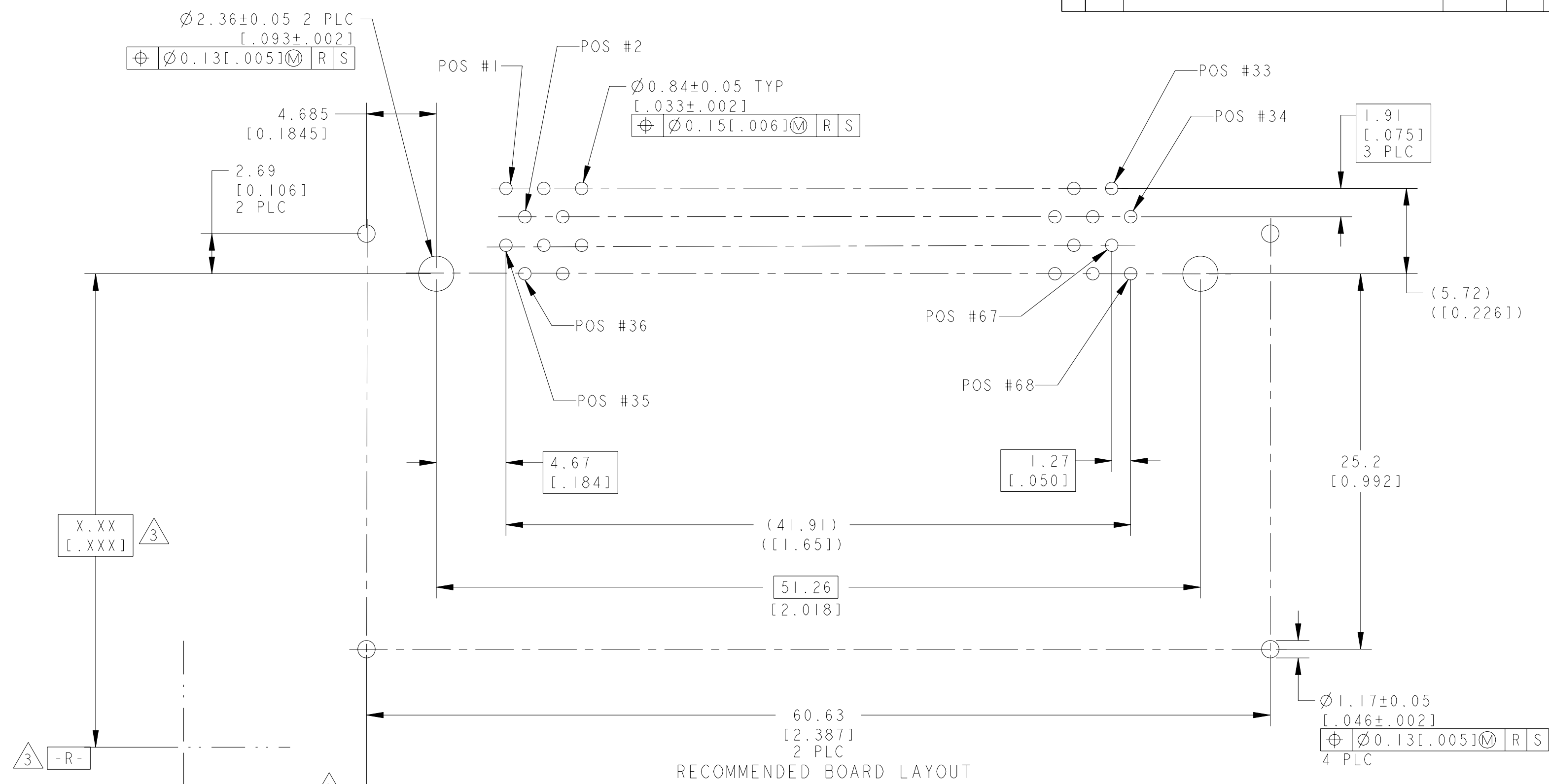




8 PLATING: 0.08μ[.00315μ] GOLD OVER 0.69μm PALLADIUM-NICKEL IN CONTACT AREA.
2μ[.07874μ] TIN ON SOLDER TAILS
1.3μ[.05118μ] - 4μ[.1575μ] NICKEL ALL OVER